



Photocoupler

Product Data Sheet

LTV-50L series

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LITE-ON DCC

RELEASE

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Photocoupler LTV-50L series

Stretched SO6, 1MBd Digital Optocoupler

1. DESCRIPTION

The LTV-50L series consists of a high efficient AlGaAs Light Emitting Diode and a high speed optical detector. This design provides excellent AC and DC isolation between the input and output sides of the Optocoupler. The output of the optical detector features an open collector Schottky clamped transistor. The internal shield ensures high common mode transient immunity. A guaranteed common mode transient immunity is up to 15KV/ μ s (min.). The Optocoupler operational parameters are guaranteed over the temperature range from -55°C ~ +100°C.

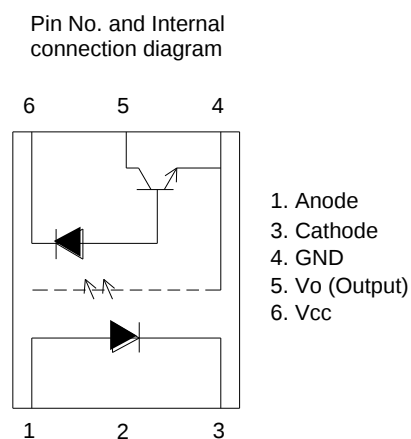
1.1 Features

- Stretched SO6
- High speed – 1MBd typical
- Package clearance / creepage at 8mm
- Compatible with infrared vapor phase reflow and wave soldering process
- Very high common mode transient immunity: 15K V/ μ s at VCM = 1500 V guaran
- Guarantee performance from temperature range: -55°C to 100°C
- TTL compatible
- Open collector output
- Safety approval :
- UL 1577 recognized with 5000 V_{rms} for 1 minute for
LTV-50LP and LTV-50LW
VDE DIN EN 60747-5-5 Approved
VIORM = 891Vpeak for LTV-50LP
VIORM = 1140Vpeak for LTV-50LW

1.2 Applications

- Digital signal isolation
- Communications interface
- Micro-controller interface
- Feedback elements in switching power supplies
- Digital isolation for A/D, D/A conversion Digital field

Functional Diagram



A 0.1 μ F bypass Capacitor must be connected between Pin 4 and 6.

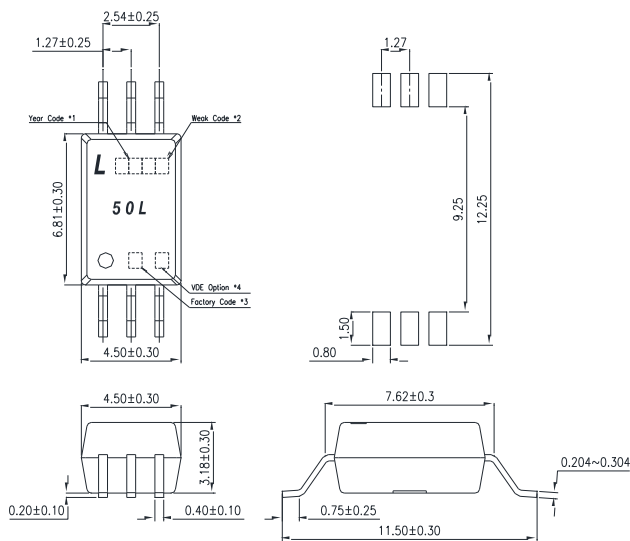
Truth Table (Positive Logic)

LED	OUT
ON	LOW
OFF	HIGH

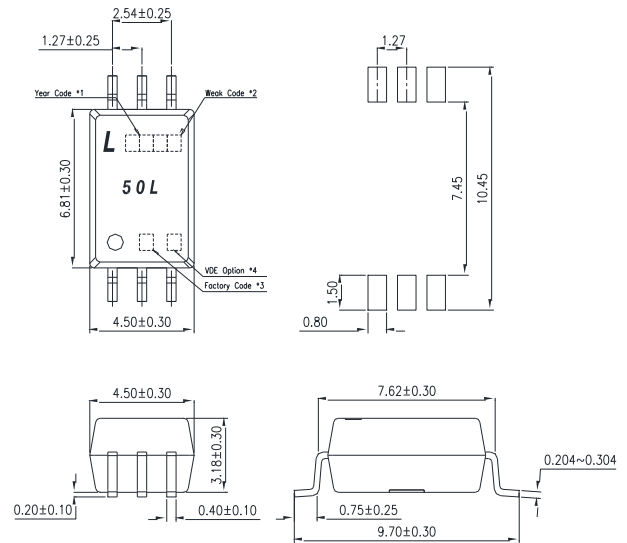
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2. PACKAGE DIMENSIONS

2.1 LTV-50LW



2.2 LTV-50LP



Notes :

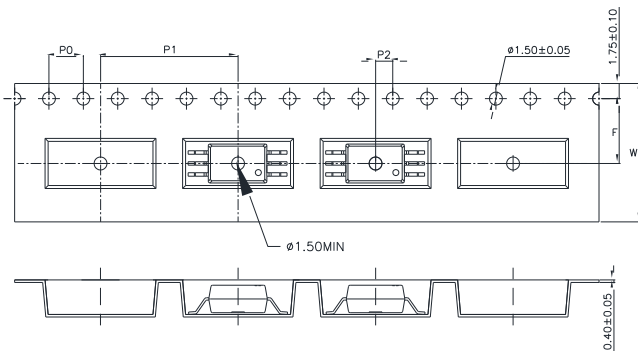
1. Year date code.
2. 2-digit work week.
3. Factory identification mark (Y : Thailand).
4. "4" or "V" for VDE option.

* Dimensions are in Millimeters and (Inches).

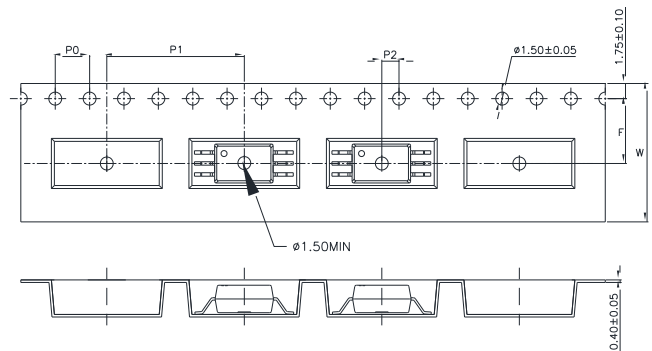
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3. TAPING DIMENSIONS

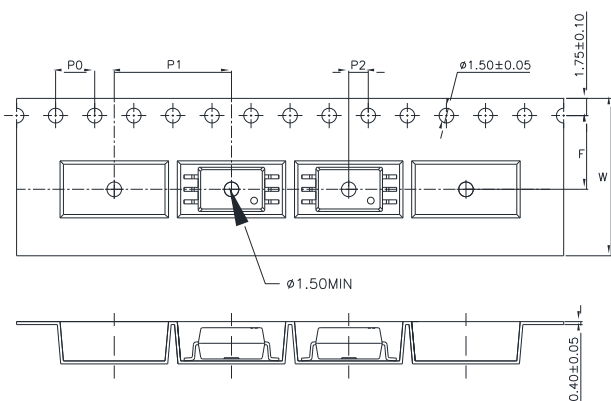
3.1 LTV-50LW-TA



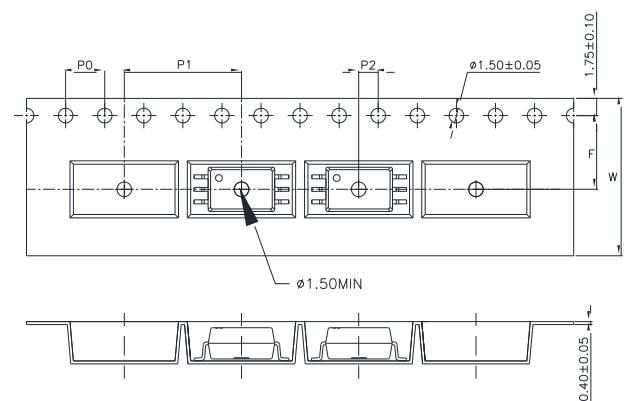
3.2 LTV-50LW-TA1



3.3 LTV-50LP-TA



3.4 LTV-50LP-TA1



Description	Symbol	Dimension in mm (inch) For W type	Dimension in mm (inch) For P type
Tape wide	W	16 $\pm$ 0.3 (0.63)	16 $\pm$ 0.3 (0.63)
Pitch of sprocket holes	P ₀	4 $\pm$ 0.1 (0.16)	4 $\pm$ 0.1 (0.16)
Distance of compartment	F	7.5 $\pm$ 0.1 (0.3)	7.5 $\pm$ 0.1 (0.3)
	P ₂	2 $\pm$ 0.1 (0.079)	2 $\pm$ 0.1 (0.079)
Distance of compartment to compartment	P ₁	16 $\pm$ 0.1 (0.63)	12 $\pm$ 0.1 (0.47)

3.5 Quantities Per Reel

Package Type	LTV-50L series
Quantities (pcs)	1000

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4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Units	Note
Storage Temperature	T_{ST}	-55	125	$^{\circ}\text{C}$	—
Operating Temperature	T_A	-55	100	$^{\circ}\text{C}$	—
Isolation Voltage	V_{ISO}	5000	—	V_{RMS}	—
Supply Voltage	V_{CC}	-0.5	30	V	—
Lead Solder Temperature	—	—	260	$^{\circ}\text{C}$	2
Input					
Average Forward Input Current	I_F	—	25	mA	—
Peak Input Current (50% duty cycle, 1 ms pulse width)	I_F	—	50	mA	—
Peak Transient Input Current (1 μs pulse width, 300 pps)	I_F	—	1.0	A	—
Reverse Input Voltage	V_R	—	5	V	—
Input Power Dissipation	P_I	—	45	mW	—
Output					
Output Collector Current	I_O	—	8	mA	—
Peak Output Current	I_O	—	16	mA	—
Output Collector Voltage	V_O	-0.5	20	V	—
Output Collector Power Dissipation	P_O	—	100	mW	—

1. Ambient temperature = 25°C , unless otherwise specified. Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.
2. 260°C for 10 seconds.

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4.2 Electrical Optical Characteristics

Parameters	Test Condition	Symbol	Min	Typ	Max	Units
Input						
Input Forward Voltage	$I_F = 16\text{mA}$, $T_A = 25^\circ\text{C}$	V_F	1.2	1.4	1.8	V
Input Reverse Voltage	$I_R = 10\mu\text{A}$	BV_R	5	—	—	V
Detector						
Current transfer ratio	$I_F = 16\text{mA}$; $V_{CC} = 4.5\text{V}$; $T_A = 25^\circ\text{C}$; $V_O = 0.4\text{V}$	CTR	20	32	—	%
	$I_F = 16\text{mA}$; $V_{CC} = 4.5\text{V}$; $T_A = 25^\circ\text{C}$; $V_O = 0.5\text{V}$		15	33	—	
Logic low output voltage output voltage	$I_F = 16\text{mA}$; $V_{CC} = 4.5\text{V}$; $I_O = 3.0\text{mA}$; $T_A = 25^\circ\text{C}$	V_{OL}	—	0.2	0.4	V
	$I_F = 16\text{mA}$; $V_{CC} = 4.5\text{V}$; $I_O = 2.4\text{mA}$; $T_A = 25^\circ\text{C}$		—	—	0.5	
Logic high output current	$I_F = 0\text{mA}$, $V_O = V_{CC} = 5.5\text{V}$, $T_A = 25^\circ\text{C}$	I_{OH}	—	0.002	0.5	μA
	$I_F = 0\text{mA}$, $V_O = V_{CC} = 15\text{V}$ $T_A = 25^\circ\text{C}$		—	0.005	1	
	$T_A = 0 \sim 70^\circ\text{C}$		—	—	50	
Logic low supply current	$I_F = 16\text{mA}$, $V_O = \text{open}$ ($V_{CC} = 30\text{V}$)	I_{CCL}	—	165		
Logic high supply current	$I_F = 0\text{mA}$, $V_O = \text{open}$; $T_A = 25^\circ\text{C}$ ($V_{CC} = 30\text{V}$)	I_{CCH}	—	0.002	1	

*All Typical values at $T_A = 25^\circ\text{C}$ unless otherwise specified. All minimum and maximum specifications are at recommended operating condition.

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5. SWITCHING SPECIFICATION

Parameter	Test Condition		Symbol	Min	Typ	Max	Units
Propagation Delay Time to Low Output Level	T _A = 25°C	R _L =1.9KΩ	t _{PHL}	—	190	800	ns
	0 ~ 100°C			—	—	800	
Propagation Delay Time to High Output Level	T _A = 25°C		t _{PLH}	—	150	800	
	0 ~ 100°C			—	—	800	
Logic High Common Mode Transient Immunity	I _F = 0mA;V _{CM} = 1500Vp-p; C _L = 15 pF; T _A =25 °C, R _L =1.9KΩ		CM _H	15	25	—	KV/μs
Logic Low Common Mode Transient Immunity	I _F = 16mA;V _{CM} = 1500Vp-p C _L = 15 pF; T _A = 25 °C, = 1.9KΩ		R _L CM _L	15	25	—	KV/μs

*All Typical values at $T_A = 25^{\circ}\text{C}$ unless otherwise specified. All minimum and maximum specifications are at recommended operating condition.

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6. ISOLATION CHARACTERISTIC

Parameter	Test Condition	Symbol	Min	Typ	Max	Units
Input-Output Insulation Leakage Current	45% RH, t = 5s, V _{I-O} = 3kV DC, T _A = 25°C	I _{I-O}	—	—	1.0	μA
Withstand Insulation Test Voltage	RH ≤ 50%, t = 1min, T _A = 25°C	V _{ISO}	5000	—	—	V _{rms}
Input-Output Resistance	V _{I-O} = 500V DC	R _{I-O}	—	10 ¹²	—	Ω

*All Typical values at T_A = 25°C unless otherwise specified. All minimum and maximum specifications are at recommended operating condition.

Notes:

- 1) A 0.1μF or bigger bypass capacitor for V_{CC} is needed.
- 2) Peaking driving circuit may be used to speed up the LED. The peak drive current of LED may go up to 50mA and maximum pulse width 50ns, as long as average current doesn't exceed 20mA.
- 3) t_{PLH} (propagation delay) is measured from the 3.75 mA point on the falling edge of the input pulse to the 1.5 V point on the rising edge of the output pulse.
- 4) t_{PHL} (propagation delay) is measured from the 3.75 mA point on the rising edge of the input pulse to the 1.5 V point on the falling edge of the output pulse.
- 5) CMH is the maximum tolerable rate of rise of the common mode voltage to assure that the output will remain in a high logic state
- 6) CML is the maximum tolerable rate of fall of the common mode voltage to assure that the output will remain in a low logic state
- 7) Device is considered a two-terminal device: pins 1, 2, 3 shorted together, and pins 4, 5, 6 shorted together.
- 8) In accordance with UL1577, each optocoupler is proof tested by applying an insulation test voltage 6000 V_{rms} for one second (leakage current less than 10 uA).

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7. TYPICAL PERFORMANCE CURVES & TEST CIRCUITS

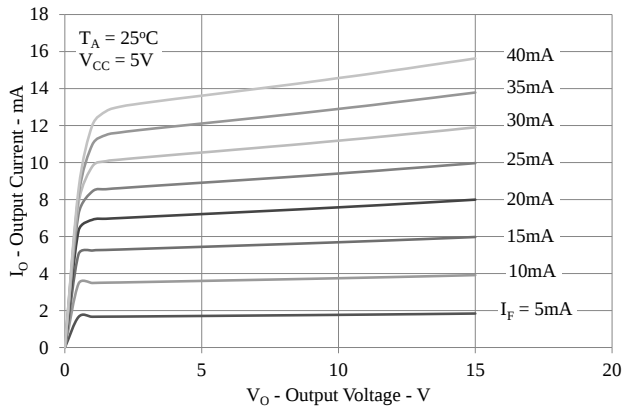


Figure 1: DC and Pulsed Transfer Characteristics

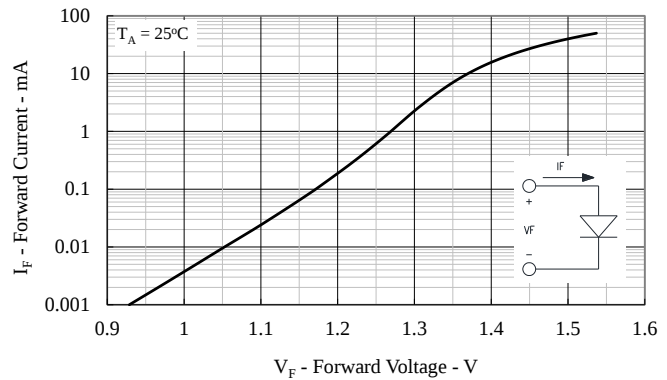


Figure 2: Input Current vs. Forward Voltage

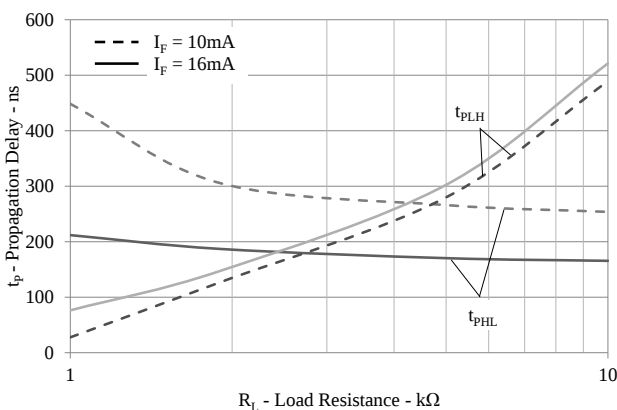


Figure 3: Propagation Delay vs. Load Resistance.

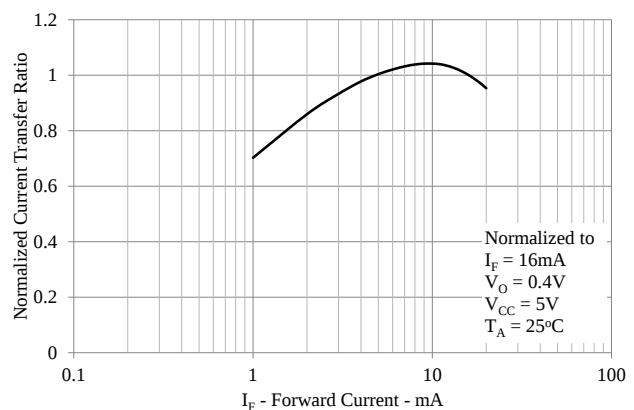


Figure 4: Current Transfer Ratio vs. Input Current.

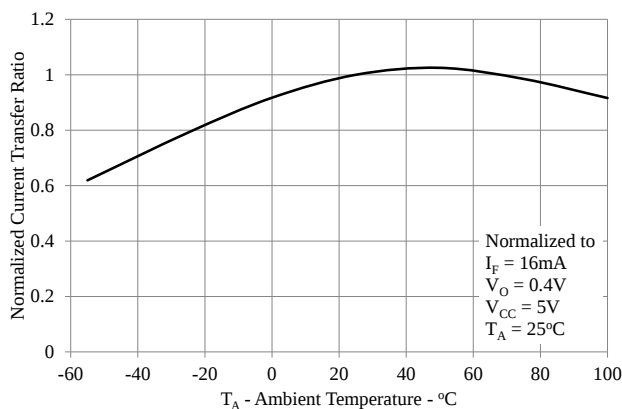


Figure 5: Current Transfer Ratio vs. Temperature.

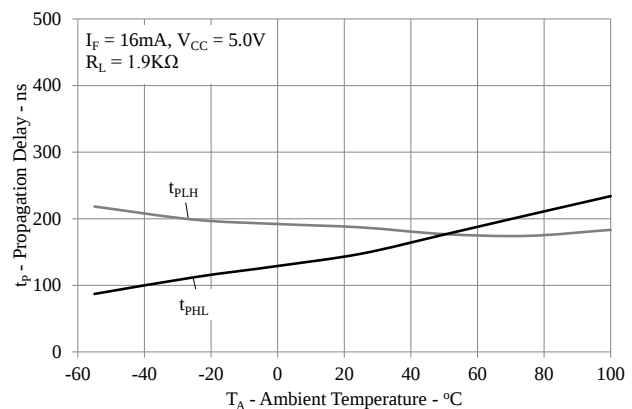


Figure 6: Propagation Delay Time vs. Temperature.

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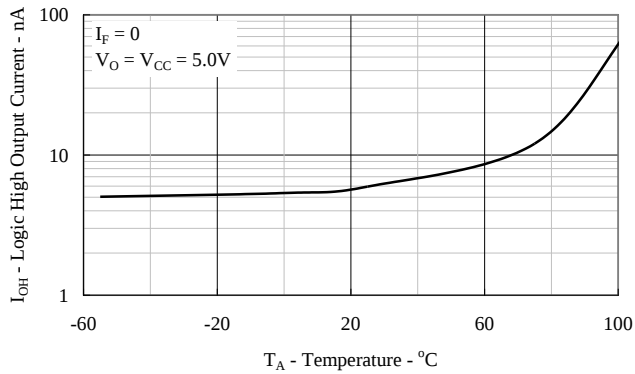


Figure 7: Logic High Output Current vs. Temperature.

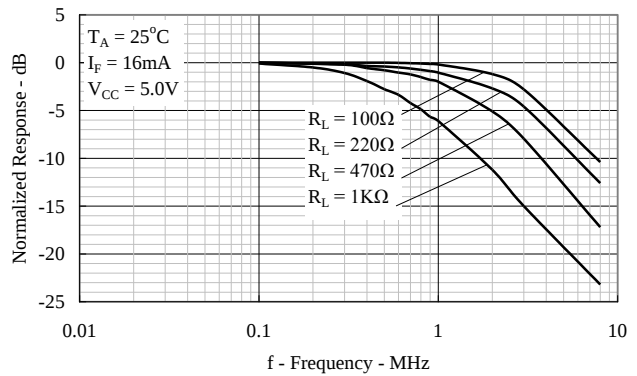


Figure 8: Frequency Response

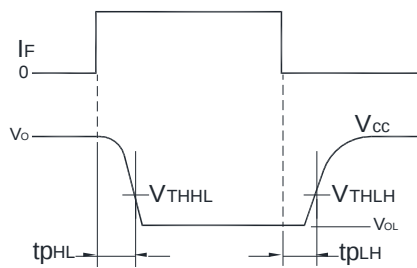


Figure 9: Switching Test Circuit

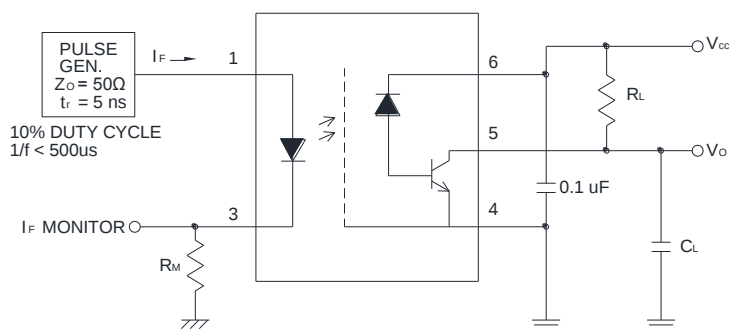
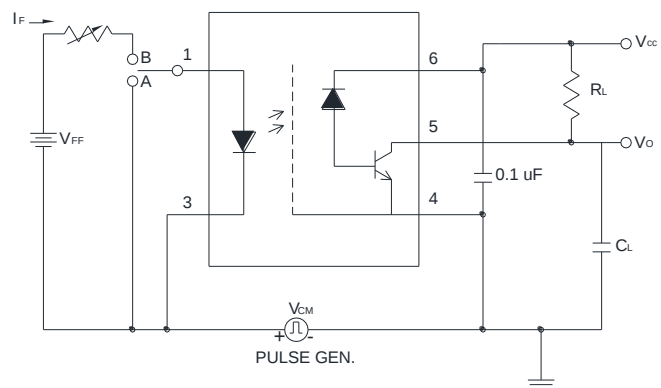
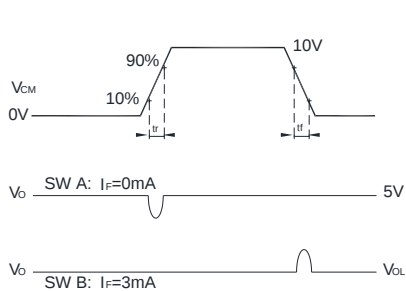


Figure 10: Test Circuit for Transient Immunity and Typical Waveforms



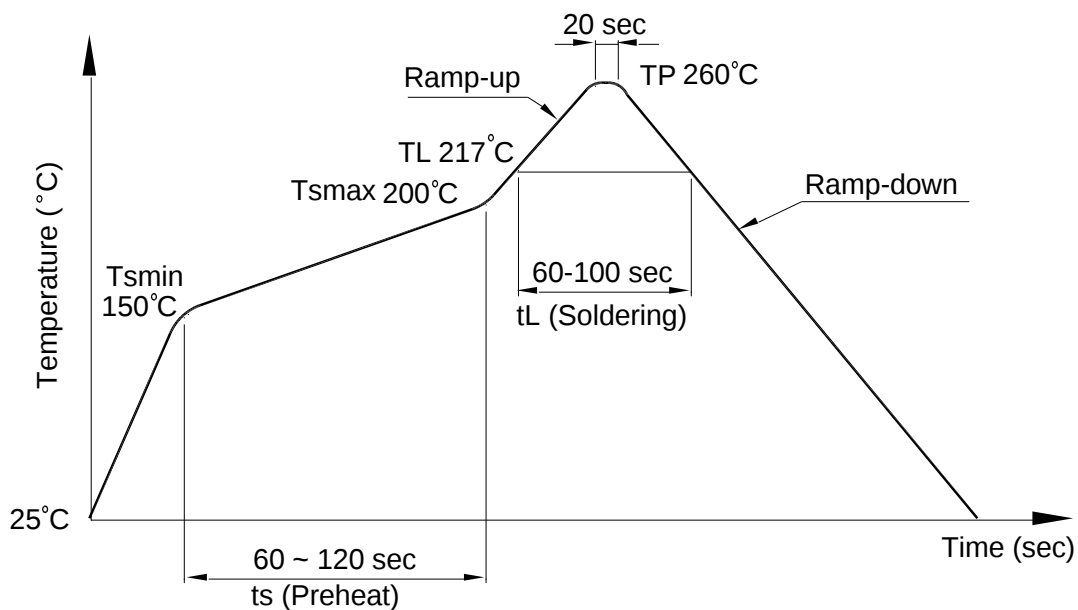
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8. TEMPERATURE PROFILE OF SOLDERING

8.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min (T_{Smin})	150°C
- Temperature Max (T_{Smax})	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature (T_L)	217°C
- Time (t_L)	60 ~ 100 sec
Peak Temperature (T_P)	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



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8.2 Wave soldering (JEDEC22A111 compliant)

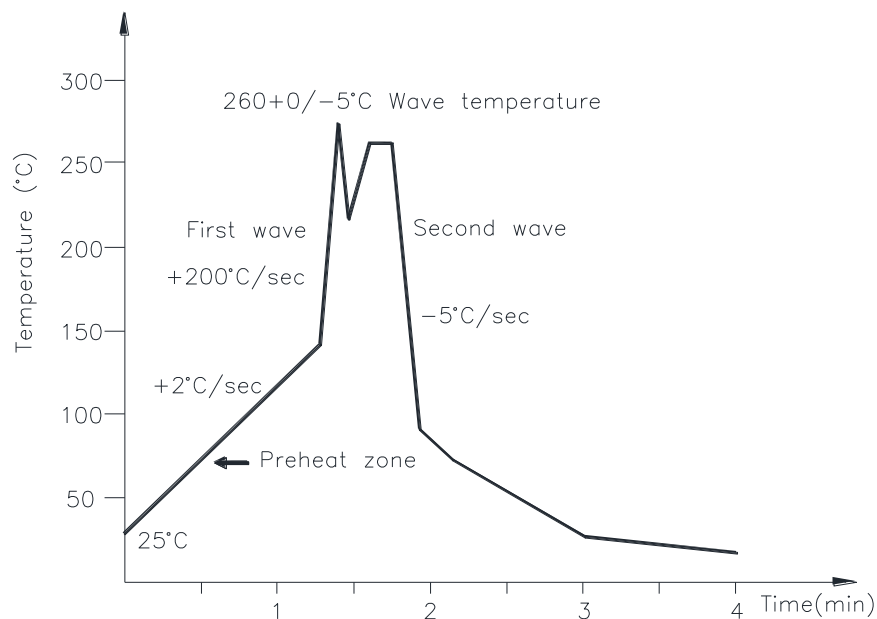
One time soldering is recommended within the condition of temperature.

Temperature: $260 \pm 0/-5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to 140°C

Preheat time: 30 to 80 sec.



8.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: $380 \pm 0/-5^{\circ}\text{C}$

Time: 3 sec max.

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9. NAMING RULE

Part number Options
LTV-50LP-TA
LTV-50LP-TA1
LTV-50LW-TA
LTV-50LW-TA1
LTV50LPTA-V
LTV50LPTA1-V
LTV50LWTA-V
LTV50LWTA1-V

Definition of Suffix	Remark
"50L"	LiteOn model name
"P"	clearance distance 9.7mm typical
"W"	clearance distance 11.5mm typical
"TA"	Pin 1 location at lower right of the tape
"TA1"	Pin 1 location at upper left of the tape
"V"	VDE approved option

10. Notes

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.